

tentative

XPT IGBT

V_{CES} = 1200V
 I_{C25} = 32A
 $V_{CE(sat)}$ = 1.8V

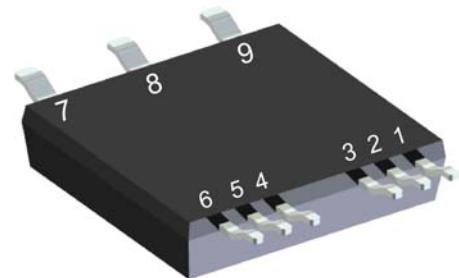
ISOPLUS™ Surface Mount Power Device

Boost Topology

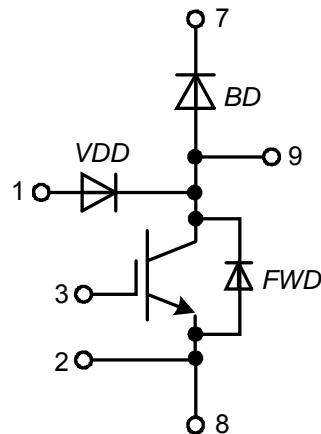
XPT IGBT

Part number

IXA20RG1200DHGLB



Backside: isolated

**Features / Advantages:**

- XPT IGBT
 - low saturation voltage
 - positive temperature coefficient for easy paralleling
 - fast switching
 - short tail current for optimized performance in resonant circuits
- Sonic™ diode
 - fast reverse recovery
 - low operating forward voltage
 - low leakage current
 - low temperature dependency of reverse recovery
- Vcesat detection diode (VDD)
 - integrated into package
 - very fast diode

Applications:

- AC drives
 - brake chopper
- PFC
 - boost chopper
- Switched reluctance drives

Package: SMPD

- Industry convenient outline
- RoHS compliant
- Epoxy meets UL 94V-0
- Soldering pins for PCB mounting
- Backside: DCB ceramic
- Reduced weight
- Advanced power cycling
- Isolation Voltage: 3000 V~

Free Wheeling Diode FWD

Symbol	Definition	Conditions	Ratings			
			min.	typ.	max.	
V_{RSM}	max. non-repetitive reverse blocking voltage	$T_{VJ} = 25^\circ C$			1200	V
V_{RRM}	max. repetitive reverse blocking voltage	$T_{VJ} = 25^\circ C$			1200	V
I_R	reverse current, drain current	$V_R = 1200 V$ $V_R = 1200 V$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$		25 0.4	μA mA
V_F	forward voltage drop	$I_F = 20 A$ $I_F = 40 A$ $I_F = 20 A$ $I_F = 40 A$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$		2.20 2.20	V V
I_{FAV}	average forward current	$T_C = 80^\circ C$ rectangular $d = 0.5$	$T_{VJ} = 150^\circ C$		18	A
V_{FO} r_F	threshold voltage slope resistance } for power loss calculation only		$T_{VJ} = 150^\circ C$		1.29 41	V mΩ
R_{thJC}	thermal resistance junction to case				1.35	K/W
R_{thCH}	thermal resistance case to heatsink			0.40		K/W
P_{tot}	total power dissipation	$T_C = 25^\circ C$			93	W
I_{FSM}	max. forward surge current	$t = 10 \text{ ms}; (50 \text{ Hz}), \text{sine}; V_R = 0 V$	$T_{VJ} = 45^\circ C$		150	A
C_J	junction capacitance	$V_R = 400 V$ $f = 1 \text{ MHz}$	$T_{VJ} = 25^\circ C$	10		pF

VCEsat Detection Diode VDD

Symbol	Definition	Conditions	Ratings			
			min.	typ.	max.	
V_{RRM}	max. repetitive reverse blocking voltage	$T_{VJ} = 25^\circ C$			1200	V
I_R	reverse current, drain current	$V_{R/D} = 1200 V$ $V_{R/D} = 1200 V$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$		2 0.03	μA mA
V_F	forward voltage drop	$I_F = 1 A$ $I_F = 1 A$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$		2.20 1.80	V V
V_{FO} r_F	threshold voltage slope resistance } for power loss calculation only		$T_{VJ} = 150^\circ C$		1.30 390	V mΩ
C_J	junction capacitance	$V_R = 400 V; f = 1 \text{ MHz}$	$T_{VJ} = 25^\circ C$	tbd		pF
I_{RM}	max. reverse recovery current		$T_{VJ} = 25^\circ C$	2.3		A
t_{rr}	reverse recovery time	$V_R = 100 V; I_F = 1 A$ $-di/dt = 100 A/\mu s$	$T_{VJ} = 125^\circ C$ $T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$	tbd 40 tbd		A ns ns

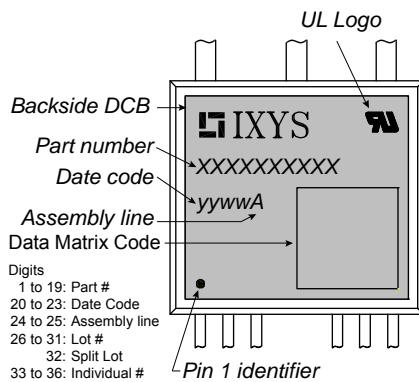
Boost IGBT

Symbol	Definition	Conditions	min.	typ.	max.	Unit	
V_{CES}	collector emitter voltage	$T_{VJ} = 25^\circ C$			1200	V	
V_{GES}	max. DC gate voltage				± 20	V	
V_{GEM}	max. transient collector gate voltage				± 30	V	
I_{C25}	collector current	$T_c = 25^\circ C$			32	A	
I_{C80}		$T_c = 80^\circ C$			23	A	
P_{tot}	total power dissipation	$T_c = 25^\circ C$			125	W	
$V_{CE(sat)}$	collector emitter saturation voltage	$I_c = 15 A; V_{GE} = 15 V$	$T_{VJ} = 25^\circ C$	1.8	2.1	V	
			$T_{VJ} = 125^\circ C$	2		V	
$V_{GE(th)}$	gate emitter threshold voltage	$I_c = 0.6 mA; V_{GE} = V_{CE}$	$T_{VJ} = 25^\circ C$	5.4	5.9	6.5	V
I_{CES}	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0 V$	$T_{VJ} = 25^\circ C$		0.1	mA	
			$T_{VJ} = 125^\circ C$		0.1	mA	
I_{GES}	gate emitter leakage current	$V_{GE} = \pm 20 V$			500	nA	
$Q_{G(on)}$	total gate charge	$V_{CE} = 600 V; V_{GE} = 15 V; I_c = 15 A$		48		nC	
$t_{d(on)}$	turn-on delay time	inductive load $V_{CE} = 600 V; I_c = 15 A$ $V_{GE} = \pm 15 V; R_G = 56 \Omega$		70		ns	
t_r	current rise time			40		ns	
$t_{d(off)}$	turn-off delay time			250		ns	
t_f	current fall time			100		ns	
E_{on}	turn-on energy per pulse			1.55		mJ	
E_{off}	turn-off energy per pulse			1.7		mJ	
RBSOA	reverse bias safe operating area	$V_{GE} = \pm 15 V; R_G = 56 \Omega$	$T_{VJ} = 125^\circ C$				
I_{CM}		$V_{CEmax} = 1200 V$			45	A	
SCSOA	short circuit safe operating area	$V_{CEmax} = 1200 V$					
t_{sc}	short circuit duration	$V_{CE} = 900 V; V_{GE} = \pm 15 V$	$T_{VJ} = 125^\circ C$		10	μs	
I_{sc}	short circuit current	$R_G = 56 \Omega$; non-repetitive		60		A	
R_{thJC}	thermal resistance junction to case				1	K/W	
R_{thCH}	thermal resistance case to heatsink			0.30		K/W	

Boost Diode BD

V_{RRM}	max. repetitive reverse voltage	$T_{VJ} = 25^\circ C$		1200	V
I_{F25}	forward current	$T_c = 25^\circ C$		27	A
I_{F80}		$T_c = 80^\circ C$		18	A
V_F	forward voltage	$I_F = 20 A$	$T_{VJ} = 25^\circ C$	2.20	V
			$T_{VJ} = 125^\circ C$	1.90	V
I_R	reverse current	$V_R = V_{RRM}$	$T_{VJ} = 25^\circ C$	0.03	mA
			$T_{VJ} = 125^\circ C$	0.12	mA
Q_{rr}	reverse recovery charge	$V_R = 600 V$ $-di_F/dt = 400 A/\mu s$ $I_F = 20 A; V_{GE} = 0 V$		3	μC
				20	A
				350	ns
				0.7	mJ
R_{thJC}	thermal resistance junction to case			1.35	K/W
R_{thCH}	thermal resistance case to heatsink			0.4	K/W

Package SMPD			Ratings			
Symbol	Definition	Conditions	min.	typ.	max.	Unit
I_{RMS}	RMS current	per terminal			100	A
T_{stg}	storage temperature		-55		150	°C
T_{VJ}	virtual junction temperature		-55		150	°C
Weight				8.5		g
F_c	mounting force with clip		40		130	N
V_{ISOL}	isolation voltage	t = 1 second t = 1 minute	50/60 Hz, RMS; $I_{ISOL} \leq 1$ mA	3000 2500		V V
$d_{Spp/App}$	creepage distance on surface striking distance through air		terminal to terminal	1.6		mm
$d_{Spb/Abp}$			terminal to backside	4.0		mm

**Part number**

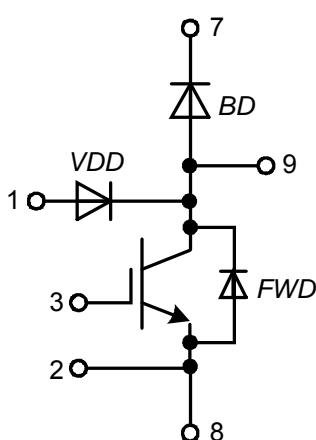
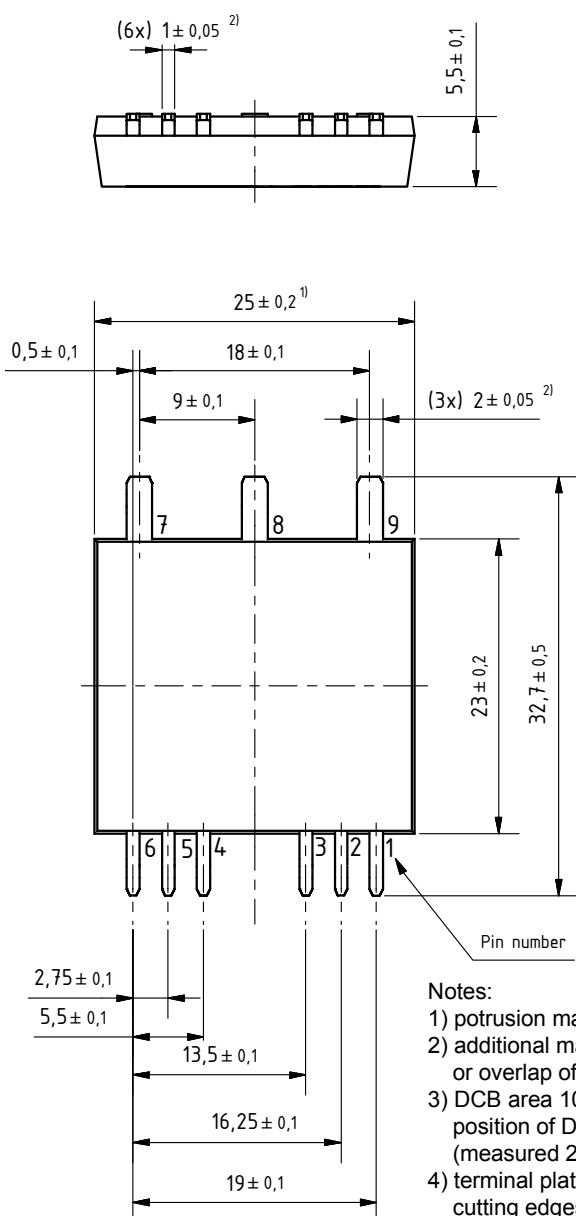
I = IGBT
 X = XPT IGBT
 A = Gen 1 / std
 20 = Current Rating [A]
 RG = boost configuration
 1200 = Reverse Voltage [V]
 D = IGBT
 H = XPT IGBT
 G = Gen 1 / std
 LB = SMPD-B

Ordering	Part Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	IXA20RG1200DHGLB	IXA20RG1200DHGLB	Blister	45	512349
Alternative	IXA20RG1200DHGLB-TRR	IXA20RG1200DHGLB	Tape & Reel	200	512370

Similar Part	Package	Voltage class
IXA30RG1200DHGLB	SMPD-B	1200
IXA40RG1200DHGLB	SMPD-B	1200

Outlines SMPD

A (8 : 1)



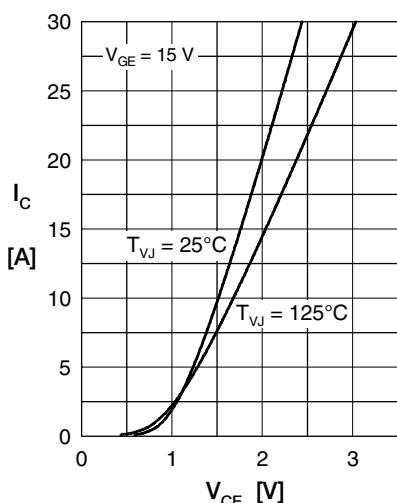
Boost IGBT

Fig. 1 Typ. output characteristics

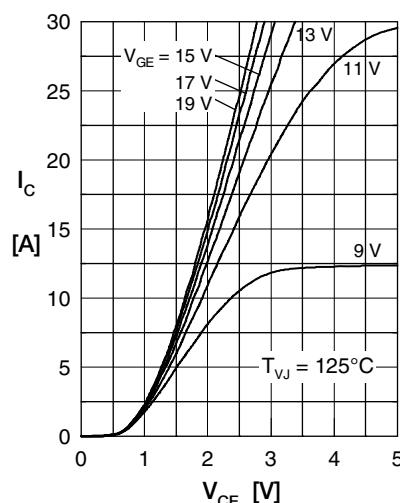


Fig. 2 Typ. output characteristics

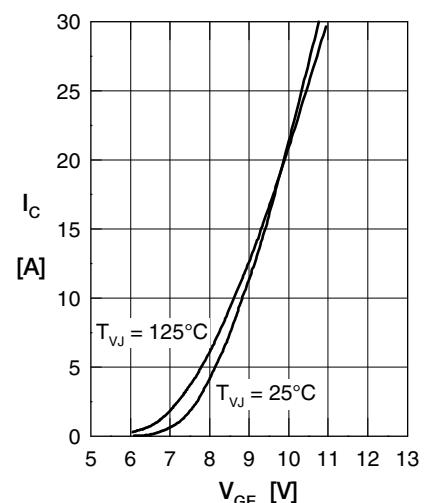


Fig. 3 Typ. tranfer characteristics

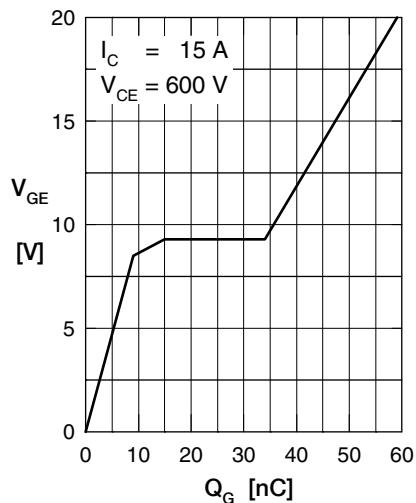


Fig. 4 Typ. turn-on gate charge

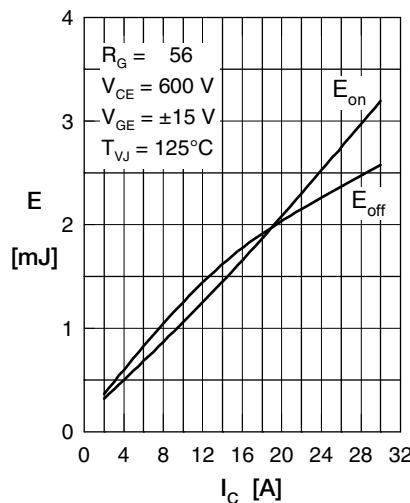


Fig. 5 Typ. switching energy versus collector current

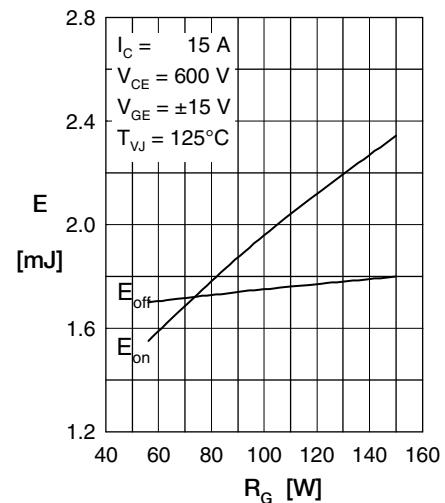


Fig. 6 Typ. switching energy versus gate resistance

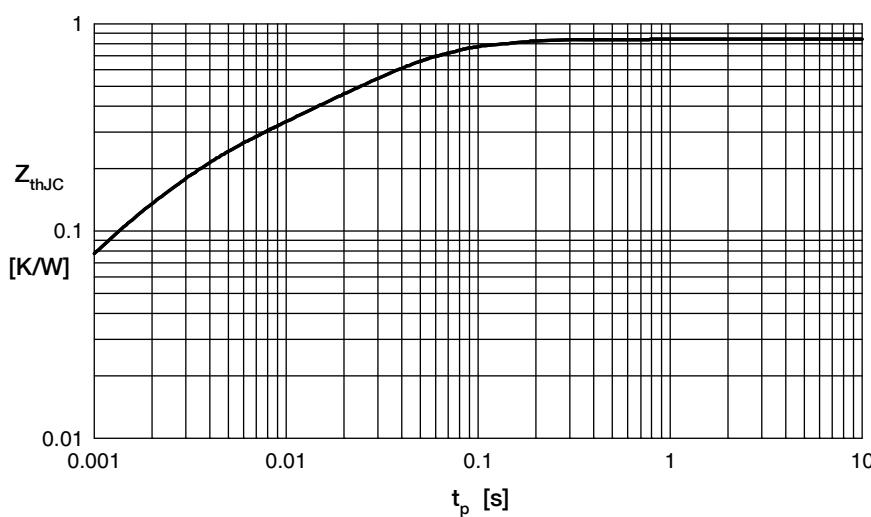


Fig. 7 Typ. transient thermal impedance junction to case

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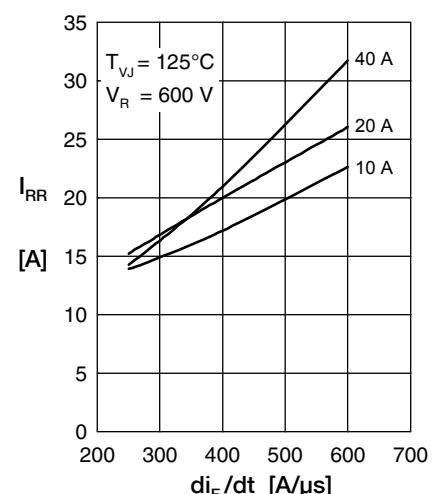
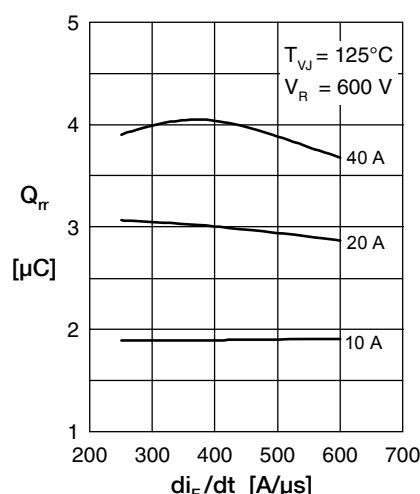
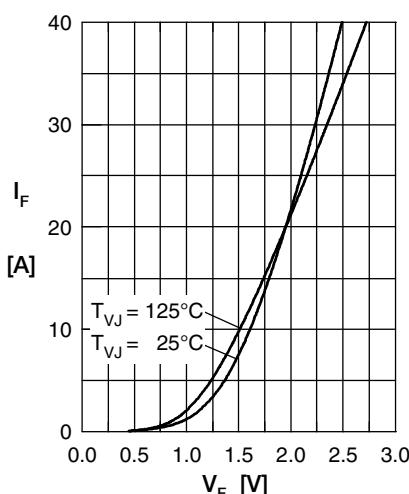


Fig. 1 Typ. Forward current versus V_F

Fig. 2 Typ. reverse recov. charge Q_{rr} versus di/dt

Fig. 3 Typ. peak reverse current I_{RM} versus di/dt

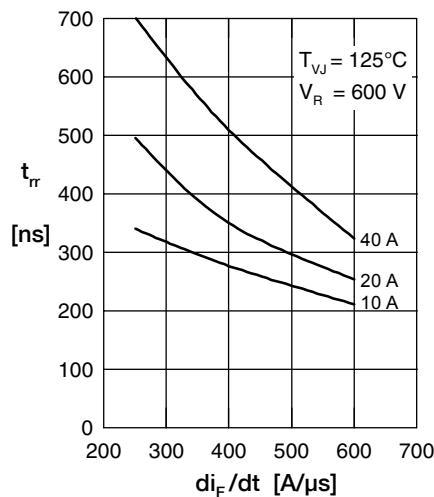


Fig. 4 Dynamic parameters Q_{rr}, I_{RM} versus di/dt

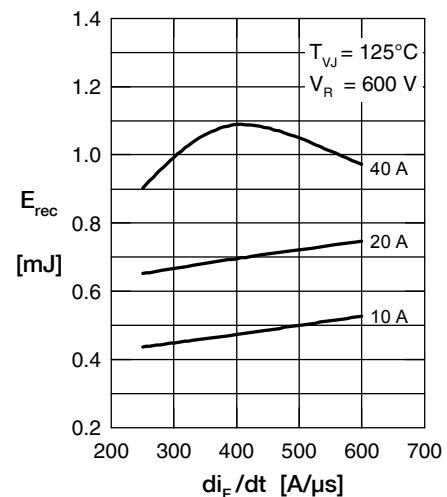
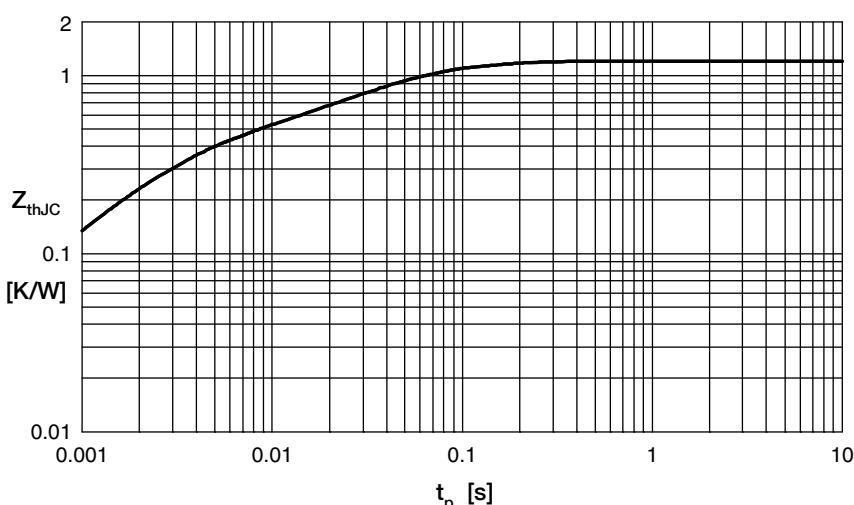


Fig. 5 Typ. recovery time t_{rr} versus di/dt





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[APT35GP120JDQ2](#) [IKZA40N65RH5XKSA1](#) [IKFW75N65ES5XKSA1](#) [IKFW50N65ES5XKSA1](#) [IKFW50N65EH5XKSA1](#)
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